

	Type	L #	Hits	Search Text	DBs
1	BRS	L1	822	257/668.ccls	USPAT; US-PGPUB
2	BRS	L2	368	257/669.ccls	USPAT; US-PGPUB
3	BRS	L3	1703	257/778.ccls	USPAT; US-PGPUB
4	BRS	L4	872	257/780.ccls	USPAT; US-PGPUB
5	BRS	L5	1127	257/784.ccls	USPAT; US-PGPUB
6	BRS	L6	290	257/673.ccls	USPAT; US-PGPUB
7	BRS	L7	1152	257/676.ccls	USPAT; US-PGPUB
8	BRS	L8	165	257/677.ccls	USPAT; US-PGPUB
9	BRS	L9	811	257/690.ccls	USPAT; US-PGPUB
10	BRS	L10	1035	257/692.ccls	USPAT; US-PGPUB
11	BRS	L11	4819	CSP or (chip adj scale adj package)	USPAT; US-PGPUB
12	BRS	L12	271	L1 and (bump or ball) and (resin or encapsulant)	USPAT; US-PGPUB
13	BRS	L13	80	L2 and (bump or ball) and (resin or encapsulant)	USPAT; US-PGPUB
14	BRS	L14	892	L3 and (bump or ball) and (resin or encapsulant)	USPAT; US-PGPUB
15	BRS	L15	442	L4 and (bump or ball) and (resin or encapsulant)	USPAT; US-PGPUB
16	BRS	L16	367	L5 and (bump or ball) and (resin or encapsulant)	USPAT; US-PGPUB
17	BRS	L17	131	L6 and (bump or ball) and (resin or encapsulant)	USPAT; US-PGPUB
18	BRS	L18	258	L7 and (bump or ball) and (resin or encapsulant)	USPAT; US-PGPUB

	Type	L #	Hits	Search Text	DBs
19	BRS	L19	14	L8 and (bump or ball) and (resin or encapsulant)	USPAT; US-PGPUB
20	BRS	L20	236	L9 and (bump or ball) and (resin or encapsulant)	USPAT; US-PGPUB
21	BRS	L21	302	L10 and (bump or ball) and (resin or encapsulant)	USPAT; US-PGPUB
22	BRS	L22	1674	L11 and (bump or ball) and (resin or encapsulant)	USPAT; US-PGPUB
23	BRS	L23	257	257/668.ccls	EPO; JPO; IBM_TDB
24	BRS	L24	91	257/673.ccls	EPO; JPO; IBM_TDB
25	BRS	L25	669	CSP or (chip adj scale adj package)	EPO; JPO; IBM_TDB